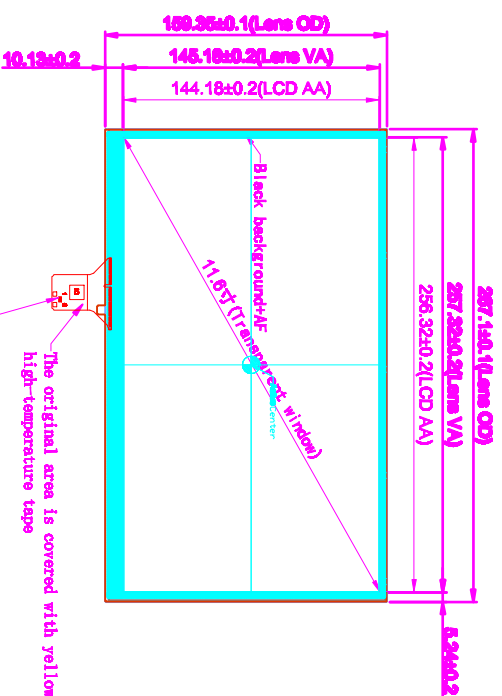


NOTES:  
1. ALL MATERIALS AND COMPONENTS MUST BE ROHS COMPLIANT.

Rev	Date	Content	Approved
V1	2023-06-03	新图纸	CHEN

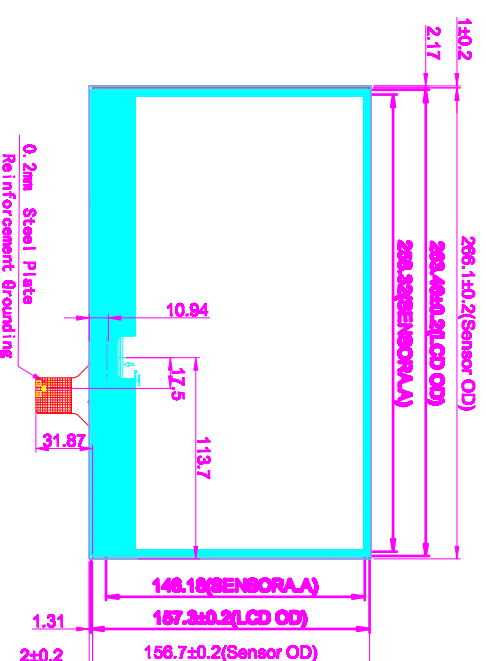
front view



side view



Back View



PIN/FUNCTION
1. GABIC ENVM
2. H. GND
3. Lave1 N
4. Lave1 P
5. H. GND
6. Lave2 N
7. Lave2 P
8. H. GND
9. AUX CHIP
10. AUX CHN
11. H. GND
12. LCD VDD
13. LCD VDD
14. NC
15. LCD GND
16. LCD GND
17. HPO
18. LED-1
19. LED-1
20. LED-3
21. LED-4
22. BL ENVBLE
23. BL PWM DM
24. SCL I/O
25. SDA I/O
26. BL PWM
27. BL PWM
28. BL PWM
29. BL PWM
30. NC

技术参数 (Technical specification):

- 产品结构 (Product Structure): COVER GLASS + ITO GLASS + FPC
- 表面硬度 (Surface Hardness): 28H
- 透光率 (Transmittance): ≥85%
- 通道数 (Channel Number): GT828 (TX32+RX20)
- 工作环境 (Operating Environment): -20℃~+70℃, 80%RH
- 储存环境 (Storage Environment): -20℃~+70℃, 80%RH

TP logic diagram

Pin	Name
1	OUT 3.3V
2	OUT 3.3V
3	GND
4	INPT 3.3V
5	INT 3.3V
6	VDD 3.3V

NOTES:  
1. LED CONNECTION:  
The table used for the first time is the table.  
2. The LED is not used for the first time.  
3. The LED is not used for the first time.  
4. The LED is not used for the first time.  
5. The LED is not used for the first time.  
6. The LED is not used for the first time.  
7. The LED is not used for the first time.  
8. The LED is not used for the first time.  
9. The LED is not used for the first time.

If You Have Any Question, Please Contact With Us / Please Confirm This Drawing On/Before